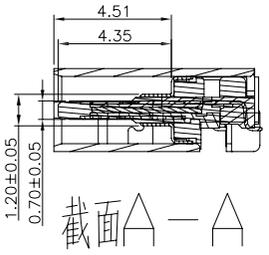
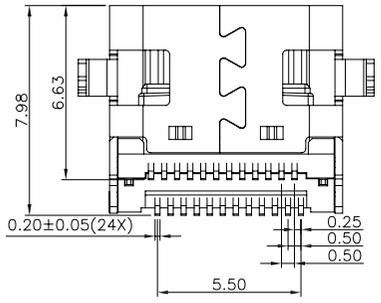
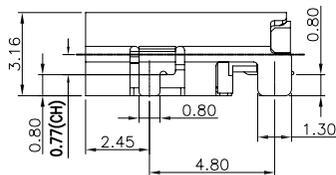
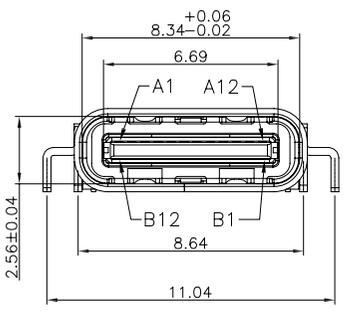


NOTE:
 1.MATERIAL SPECIFICATION:
 1.HOUSING:HIGH TEMPERATURE RESISTANT PLASTIC,UL94 V-0.
 2.CONTACTS:COPPER ALLOY
 3.MID PLATE: STAINLESS STEEL
 4.FRONT SHELL: STAINLESS STEEL
 5.EMI PLATE: STAINLESS STEEL
 2.PLATING SPECIFICATION:
 2-1.CONTACTS:
 Ni 50u" MIN. UNDER PLATED OVER ALL.
 Au PLATED ON THE FUNCTIONAL AREA OF CONTACT.
 PLATING Au ON THE SOLDER AREA
 2-2.FRONT SHELL.
 Ni 30u" MIN. UNDER PLATED OVER ALL.
 2-3.MID PLATE&EMI PLATE:
 CLEAR ONLY
 3.MECHANICAL PERFORMANCE,
 3-1.INSERTION FORCE: 5~20N.
 3-2.REMOVAL FORCE: 8~20N.
 3-3.DURABILITY: 10000 CYCLES.
 4.ELECTRICAL PERFORMANCE,
 4-1. CURRENT RATING:5.0A
 VOLTAGE RATING:5.0V
 4-2. LLCR:
 VBUS & GND PINS AND OTHER PINS: 40mΩ/PIN MAX.
 SHIELD: 50mΩ/MAX.
 LLCR MAX. CHANGE OF ALL PINS: 10mΩ.
 4-3.INSULATION RESISTANCE: 100MΩ MIN
 4-4.DIELECTRIC WITHSTAND VOLTAGE,AC 100V FOR 1 MINUTE.
 5. ENVIRONMENTAL PERFORMANCE:
 OPERATING TEMPERATURE: -25?~+85?.
 6.IR REFLOW:
 THE PEAK TEMPERATURE ON THE BOARD SHALL
 BE MAINTAINED FOR 10 SECONDS AT 260°C.

RECOMMENDED PCB LAYOUT(TOP VIEW)
 THICKNESS 0.60MM;DEFAULT TOLERANCE:±0.05



		一般公差 GENERAL TOLERANCE		绘图 DR.	李兴泽	料号 PART NO.	文件编号 NUMBER	 TERMINAL&CONNECTORS		
		X.X ±0.30	X* ±2*	校对 CHK.		W-UTP-CH077-H26	ENDPT01			
		X.XX ±0.20	X.X* ±1*	审核 CHK.		品名TITLE		比例 SCALE		
		X.XXX ±0.10	▲ MAJOR DIM.	核准 APPD.		USB TYPE C 24PIN 沉板式(CH=0.77)		SHEET		
版次REV.	日期 DATE	变更内容 DESCRIPTION	审核 CHK.	核准 APPD.	单位 UNIT			版次 REV.		
A			B		C	D		E		
								F		